

/ Descriptions

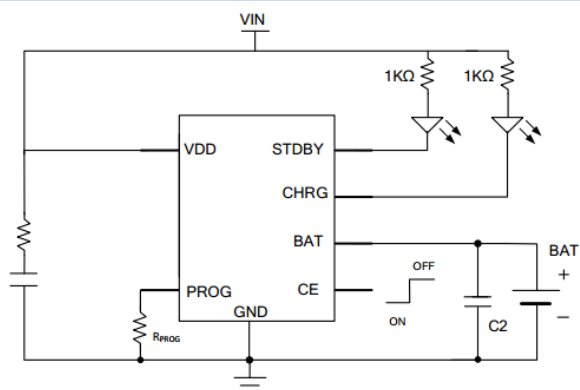
/ Features

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/ Applications

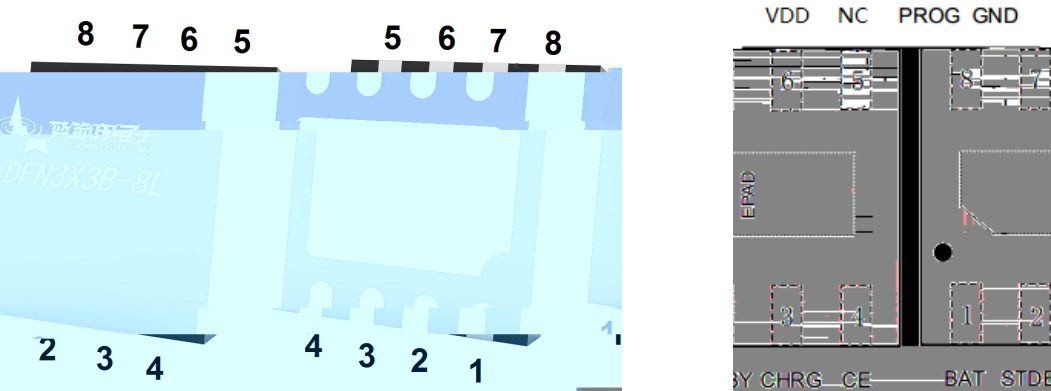
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/ Application Circuit



注 1: 建议取值 (C1/C2 为 1—10uF)

/ Pinning



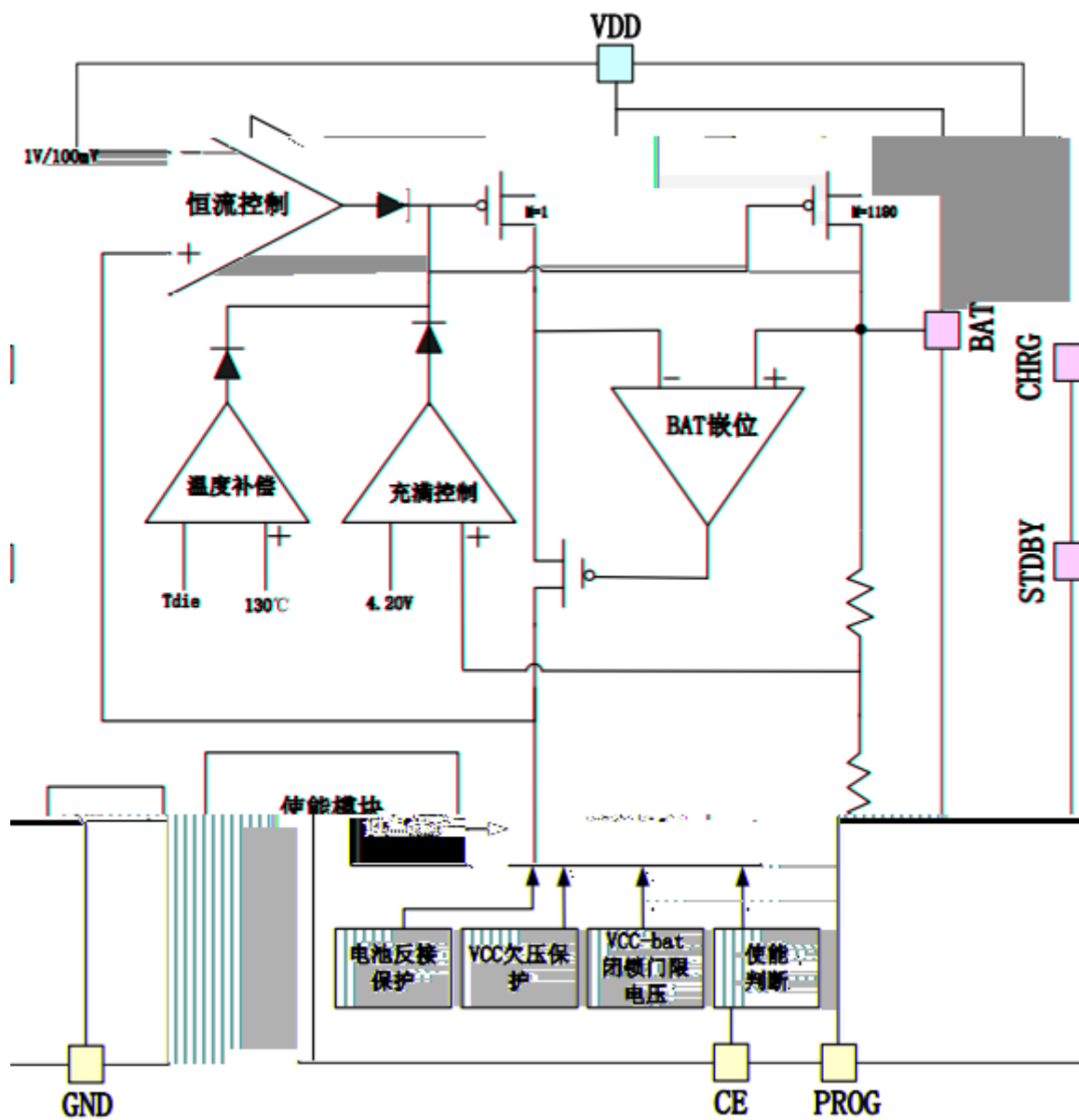
PIN Num.	Symbol	Function
	SUR J	

/ Absolute Maximum Ratings(Ta=25)

PARAMETER	SYMBOL	RATINGS	UNITS

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
	Δ					
V _{CC} Under voltage	Δ					

/ Principle block diagram



/ Function description

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/ Function description

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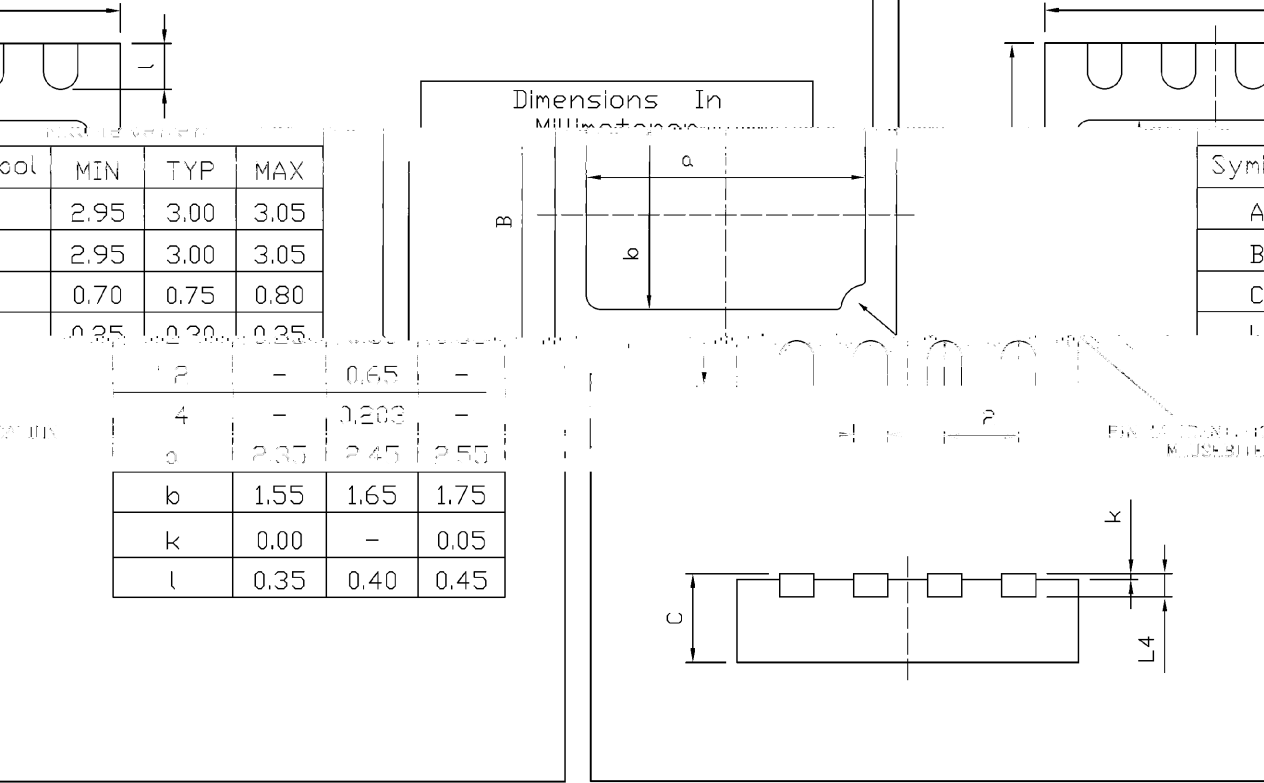
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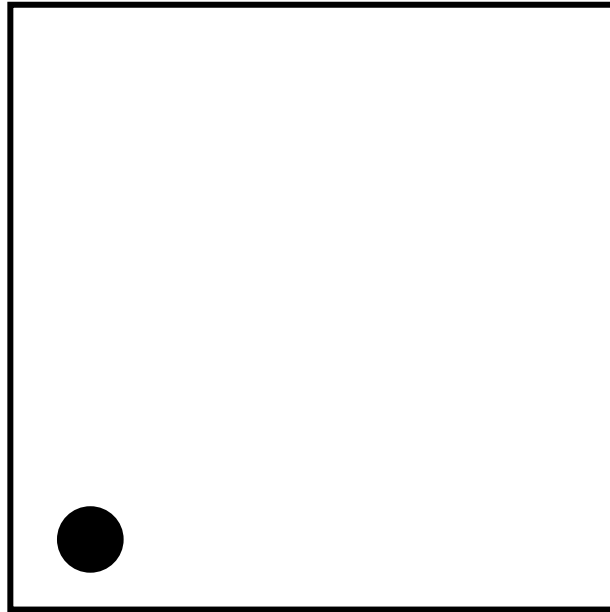
/ Package Dimensions

DFN3X3B-8L

Unit:mm

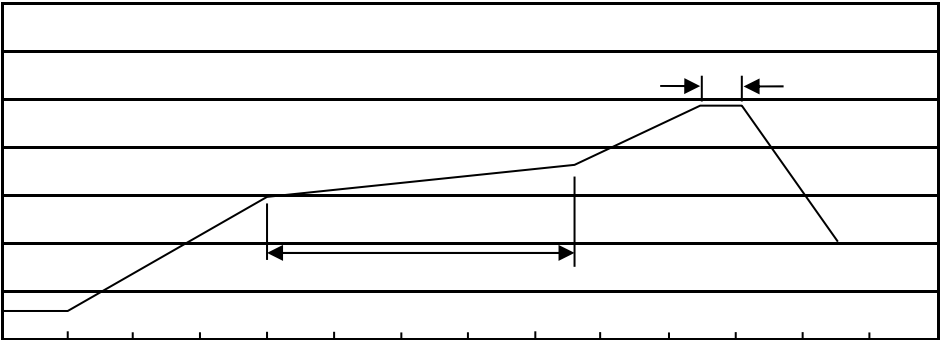


/ Marking Instructions



738;I

() / Temperature Profile for IR Reflow Soldering(Pb-Free)



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/ Resistance to Soldering Heat Test Conditions

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/ Packaging SPEC.

	Units/Reel /	Reels/Inner Box /	Units/Inner Box /	Inner Boxes/Outer Box /	Units/Outer Box /	Reel	Inner Box	Outer Box

/ Notices